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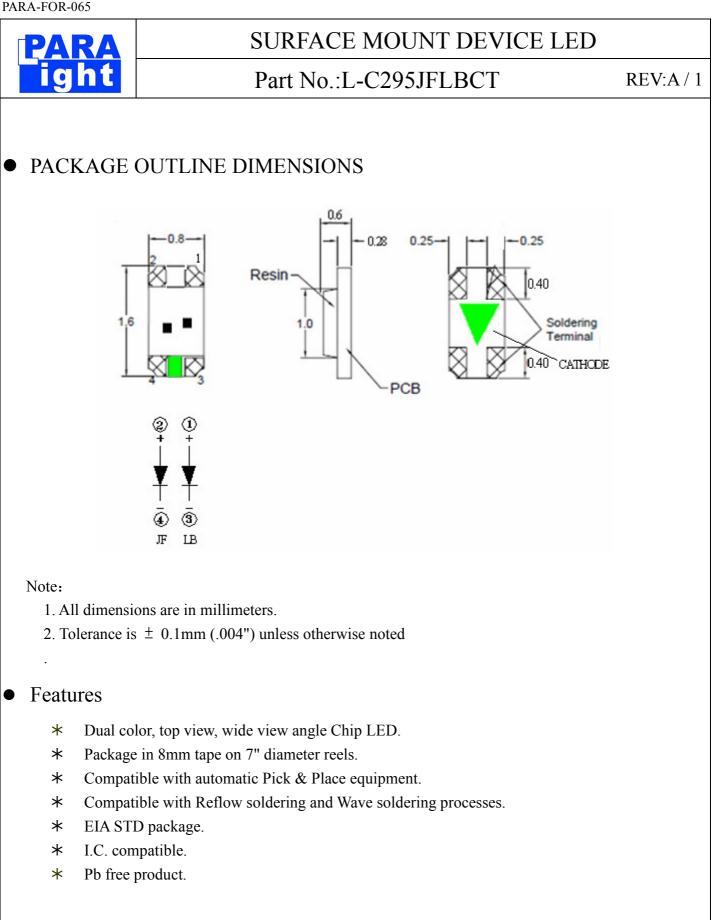
DATA SHEET

PART NO.:L-C295JFLBCT

REV: <u>A / 1</u>

CUSTOMER'S APPROVAL: DCC: DRAWING NO.: DS-76-15-004 DATE:2016-3-28 PAGE

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• Chip Materials

chip	Light Color	Dice Material	Lens Color
JF	Amber	AlInGap	Water Clear
LB	Blue	InGaN	Water Clear

• Absolute Maximum Ratings (Ta=25°C)

Sumbol	Parameter	R	Unit	
Symbol	Falameter	Amber	Blue	Unit
PD	Power Dissipation	75	100	mW
Ipf	Peak Forward Current	80	100	m A
IPF	(1/10 Duty Cycle, 0.1ms Pulse Width)	80	100	mA
IF	Continuous Forward Current	25	25	mA
-	De-rating Linear From 25°C	0.25	0.25	mA/°C
VR	Reverse Voltage	5	5	V
ESD	Electrostatic Discharge Threshold (HBM) ^{Note A}	2000	1000	V
Topr	Operating Temperature Range	-40 ~ +85		°C
Tstg	Storage Temperature Range $-40 \sim +85$		°C	
-	Vave Soldering Condition (Two times Max.)260 (for 5 seconds)		°C	

Note A:

D

HBM: Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

• Electro-Optical Characteristics (Ta=25°C)

	SYMBOL		PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	VF Amber Blue			IF = 20mA		2.0	2.4	V
			Forward Voltage	IF = 2011A		3.0	3.4	
	IV Amber Blue Luminous Intensity		IE = 20mA	112	120		mad	
			Luminous intensity	IF = 20MA	112	140		mcd
	201/2		Half Intensity Angle	IF = 20mA		130		deg
	λD	Amber	Dominant Wavelength	IF = 20mA		605		nm
	ΛD	Blue		11 - 20117		470		
	λp Amber Blue		-Peak Emission Wavelength	IF = 20mA		611		nm
						468		
Ī	Amber					17		nm
	Δλ	Blue	Spectral Line Half-Width	IF = 20mA		25		
	IR	Amber	Reverse Current	VR = 5V			10	۸
		Blue		VK - 5V			50	μA
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Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Caution in ESD:

Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

5. Major standard testing equipment by "Instrument System" Model: CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

• Typical Electro-Optical Characteristics Curves

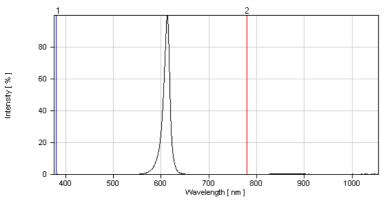
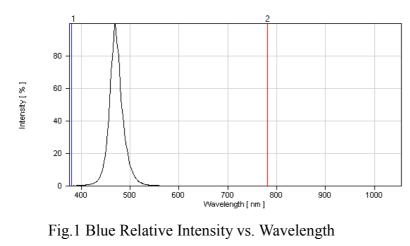


Fig.1 Amber Relative Intensity vs. Wavelength





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• Amber Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

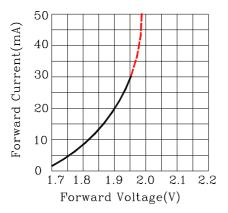


Fig.2 Forward Current vs.Forward Voltage

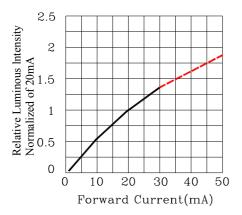
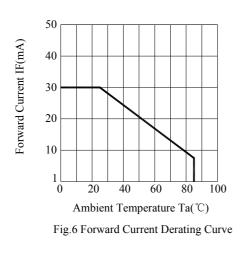


Fig.4 Relative Luminous Intensity vs.Forward Current



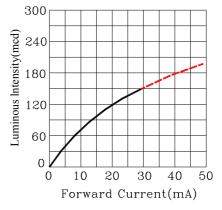
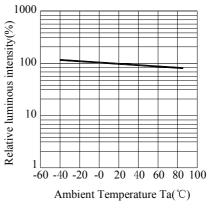
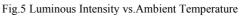


Fig.3 Luminous Intensity vs.Forward Current





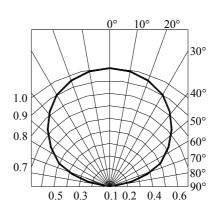


Fig.7 Relative Intensity vs.Angle



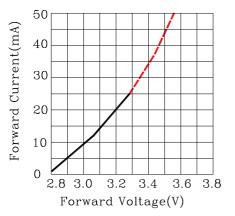


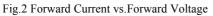
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Blue Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)





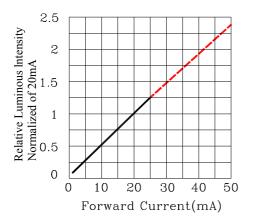
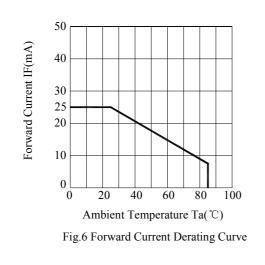


Fig.4 Relative Luminous Intensity vs.Forward Current





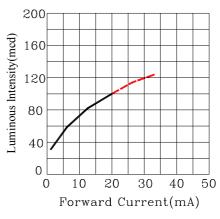


Fig.3 Luminous Intensity vs.Forward Current

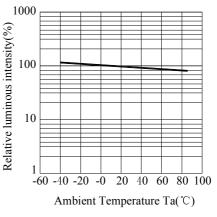
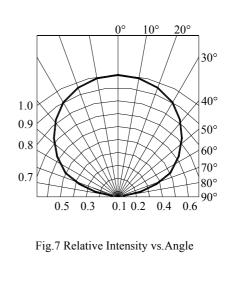


Fig.5 Luminous Intensity vs.Ambient Temperature







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• Label Explanation



ITEM CODE:PARRA LIGHT

PART NO:L-C295JFLBCT IV --- Luminous Intensity Code LOT NO: EM S L

в С А D A---EM: Emos Code B---S:SMD

- L---Local D---Year
- E---Month
- F---SPEC.

PACKING QUANTITY OF BAG :

3000pcs for 150, 170, 110, 155, 115 series

12

09

Е

0110

F

4000pcs for 191 series

5000pcs for 192 series

DATE CODE: <u>2012</u> <u>09</u> <u>10</u> G Η I

G---- Year H--- Month I --- Day

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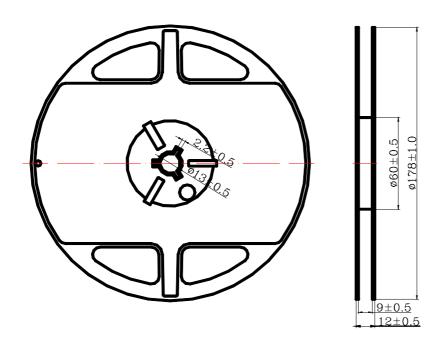
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Part No.:L-C295JFLBCT

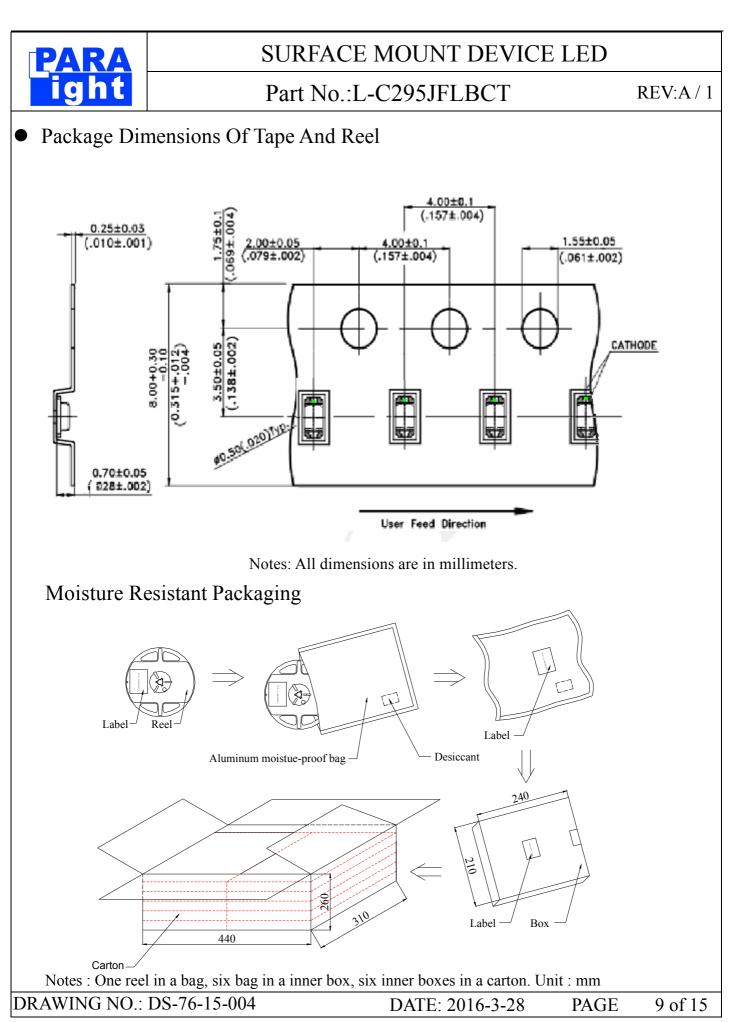
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• Reel Dimensions



Notes:

- 1. Taping Quantity: 4000pcs
- 2. The tolerances unless mentioned is ± 0.1 mm, Angle $\pm 0.5^{\circ}$, Unit: mm.



Release by PARALIGHTDCC





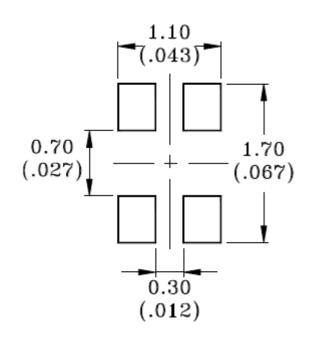
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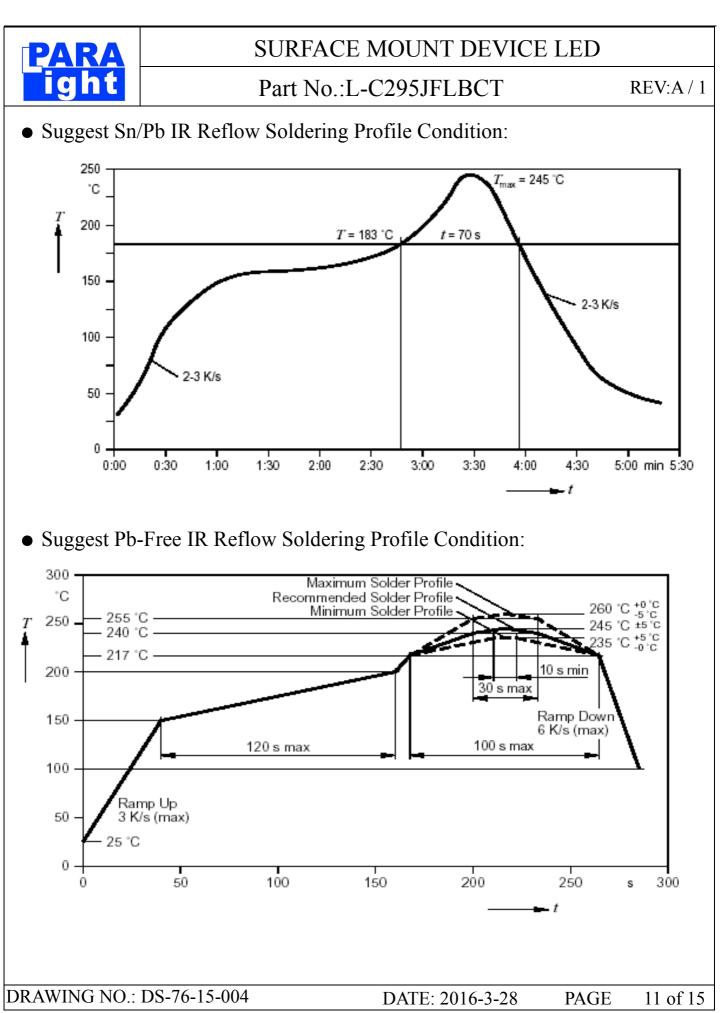
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• Cleaning

- * If cleaning is required , use the following solutions for less than 1 minute and less than 40° C.
- * Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

Suggest Soldering Pad Dimensions





Release by PARALIGHTDCC

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• Bin Code List

Luminous Intensity (IV), Unit: mcd@20mA					
Amber			Blue		
Bin Code	Min	Max	Bin Code	Min	Max
R	112	180	R	112	180
S	180	280	S	180	280

Tolerance of each bin are $\pm 15\%$

Dominant Wavelength (Hue), Unit: nm@20mA					
Amber			Blue		
Bin Code	Min	Max	Bin Code	Min	Max
OA	600	605	AC	465	470
OB	605	610	AD	470	475

Tolerance of each bin are ± 1 nm





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• CAUTIONS

1. Application Limitation:

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2.Storage:

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.

After opening the package: The LED's floor life is 1 year under 30° C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5℃ for 24 hours.

3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition.

Reflow Soldering:

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time: 10 sec Max.



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Soldering Iron: (Not Temperature 300°C	recommended)
Temperature 300°C	
	Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60
solder of solder with	silver content and don't to touch LED lens when soldering.
Wave soldering:	
	x, Pre-heat time 60 sec. Max, Solder wave 260°C Max, Soldering time 5 sec. Max. preformed
	g process is required between 1 st and 2 nd soldering processes.
4. Lead-Free Soldering	
For Reflow Solder	5
-	0:150-180°C,120sec.Max.
2 · Soldering Tem	p: Temperature Of Soldering Pot Over 230°C,40sec.Max.
3 · Peak Temperat	ure:260 $^{\circ}$ C , 5sec.
4 · Reflow Repetit	tion:3 Times Max.
5 Suggest Solder	r Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu
For Soldering Iron	(Not Recommended):
1 · Iron Tip Temp:	:350°C Max.
2 Soldering Iron:	:30w Max.
3 Soldering Time	e:3 Sec. Max. One Time.
For Dip Soldering:	
1 · Pre-Heat Temp	b:150°C Max. 120 Sec. Max.
2 • Bath Temp:265	
3 \ Dip Time:5 Sec	
5. Drive Method	
	t model A Circuit model B
(A)Recommended	circuit
	of brightness between LED's could be found due to the Vf-If characteristics of LED.



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6.Reliability Test

Classification	Test Item	Test Condition	Reference Standard		
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D: 1026 (1995) MIL-STD-883D: 1005 (1991) JIS C 7021:B-1 (1982)		
Endurance Test	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C,RH= 90~95% *Test Time= 1000HRS±2HRS	MIL-STD-202F: 103B(1980) JIS C 7021: B-11 (1982)		
	High TemperatureTa= 105±5 °CStorageTest Time= 1000HRS (-24HRS, 1000)		MIL-STD-883D: 1008 (1991) JIS C 7021:B-10 (1982)		
	Low Temperature Storage	Ta= -55±5℃ *Test Time=1000HRS (-24HRS, 72H RS)	JIS C 7021:B-12 (1982)		
Environmental Test	Temperature Cycling	$\begin{array}{cccc} 105\pm5^{\circ}\mathbb{C} & -55\pm5^{\circ}\mathbb{C} \\ 10 \text{mins} & 10 \text{mins} & 100 \text{ Cycles} \end{array}$	MIL-STD-202F: 107D (1980) MIL-STD-750D: 1051(1995) MIL-STD-883D: 1010 (1991) JIS C 7021: A-4 (1982)		
	Thermal Shock	IR-Reflow In-Board, 2 Times105±5℃-55℃±5℃10mins10mins100 Cycles	MIL-STD-202F: 107D(1980) MIL-STD-750D: 1051(1995) MIL-STD-883D: 1011(1991)		
	Solder Resistance	Tsol= $260 \pm 5^{\circ}$ C Dwell Time= 10 ± 1 sec	MIL-STD-202F: 210A(1980) MIL-STD-750D: 2031(1995) JIS C 7021: A-1 (1982)		
	Solder ability	Tsol= $235 \pm 5^{\circ}$ C Immersion time 2 ± 0.5 sec Immersion rate 25 ± 2.5 mm/sec Coverage $\geq 95\%$ of the dipped surface	MIL-STD-202F: 208D(1980) MIL-STD-750D: 2026(1995) MIL-STD-883D: 2003(1991) IEC 68 Part 2-20 JIS C 7021: A-2 (1982)		

7.Others:

The appearance and specifications of the product may be modified for improvement without notice.

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